

IGBT4 Modules

SKM450GB12E4

Features

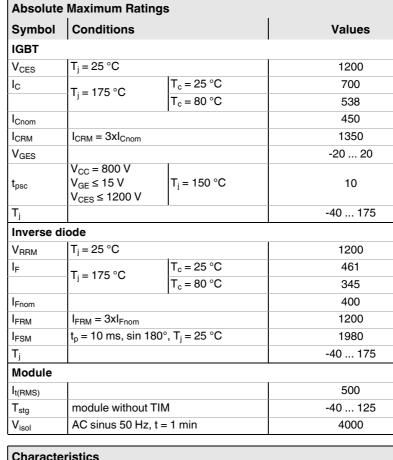
- IGBT4 = 4th generation medium fast trench IGBT (Infineon)
- CAL4 = Soft switching 4th generation CAL-diode
- Insulated copper baseplate using DBC technology (Direct Bonded Copper)
- · Increased power cycling capability
- · With integrated gate resistor
- For higher switching frequencies up to 12kHz
- UL recognized, file no. E63532

Typical Applications*

- AC inverter drives
- UPS

Remarks

- Case temperature limited to T_c = 125°C max.
- Recommended T_{op} = -40 ... +150°C
- Product reliability results valid for T_j = 150°C



Unit

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Α

Α

Α

Α

V

μs

°C

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Α

Α

Α

Α

Α

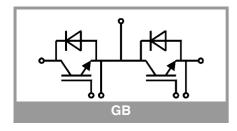
°C

Α

°С

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Characteristics									
Symbol	Conditions	min.	typ.	max.	Unit				
IGBT									
V _{CE(sat)}	$I_{\rm C} = 450 {\rm A}$	T _j = 25 °C		1.84	2.07	V			
	V _{GE} = 15 V chiplevel	T _j = 150 °C		2.23	2.42	V			
V _{CE0}	chiplevel	T _j = 25 °C		0.80	0.90	V			
		T _j = 150 °C		0.70	0.80	V			
r _{CE}	V _{GE} = 15 V chiplevel	T _j = 25 °C		2.3	2.6	mΩ			
		T _j = 150 °C		3.4	3.6	mΩ			
$V_{GE(th)}$	V _{GE} =V _{CE} , I _C = 16.4 mA		5	5.8	6.5	V			
I _{CES}	$V_{GE} = 0 \text{ V}, V_{CE} = 12$			5	mA				
C _{ies}	V 05.V	f = 1 MHz		27.2		nF			
C _{oes}	V _{CE} = 25 V V _{GE} = 0 V	f = 1 MHz		1.76		nF			
C _{res}		f = 1 MHz		1.50		nF			
Q _G	V _{GE} = - 8 V+ 15 V			2500		nC			
R _{Gint}	T _j = 25 °C			1.9		Ω			
t _{d(on)}	$\begin{array}{l} V_{CC} = 600 \; V \\ I_{C} = 450 \; A \\ V_{GE} = +15/-15 \; V \\ R_{G\;on} = 1 \; \Omega \\ R_{G\;off} = 1 \; \Omega \\ di/dt_{on} = 8100 \; A/\mu s \\ di/dt_{off} = 3400 \; A/\mu s \end{array}$	T _j = 150 °C		246		ns			
t _r		T _j = 150 °C		59		ns			
Eon		T _j = 150 °C		32		mJ			
t _{d(off)}		T _j = 150 °C		529		ns			
t _f		T _j = 150 °C		102		ns			
E _{off}		T _j = 150 °C		60		mJ			
R _{th(j-c)}	per IGBT			0.062	K/W				
R _{th(c-s)}	per IGBT (λ _{grease} =0.81 W/(m*K))			0.028		K/W			
R _{th(c-s)}	per IGBT, pre-appli material		0.017		K/W				





SEMITRANS® 3

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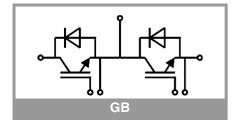
Remarks

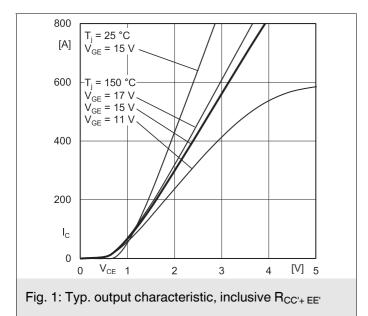
· Case temperature limited to $T_c = 125^{\circ}C$ max.

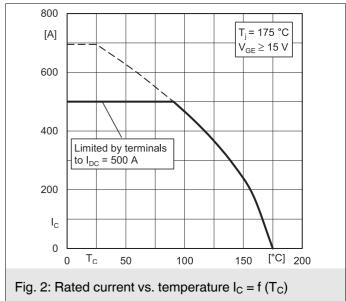
• Recommended $T_{op} = -40 \dots +150$ °C

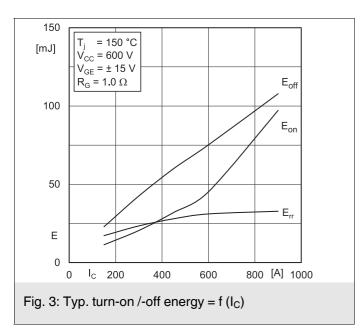
• Product reliability results valid for $T_i = 150$ °C

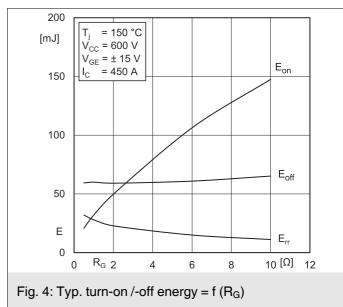
Characteristics										
Symbol	Conditions	min.	typ.	max.	Unit					
Inverse diode										
$V_F = V_{EC}$	I _F = 450 A	T _j = 25 °C		2.31	2.65	V				
	V _{GE} = 0 V chiplevel	T _j = 150 °C		2.31	2.64	V				
V _{F0}	chiplevel	T _j = 25 °C		1.30	1.50	V				
		T _j = 150 °C		0.90	1.10	V				
r _F	chiplevel	T _j = 25 °C		2.3	2.6	mΩ				
		T _j = 150 °C		3.1	3.4	mΩ				
I _{RRM}	$I_F = 450 \text{ A}$ $di/dt_{off} = 8300 \text{ A/}\mu\text{s}$ $V_{GE} = \pm 15 \text{ V}$ $V_{CC} = 600 \text{ V}$	T _j = 150 °C		452		Α				
Q _{rr}		T _j = 150 °C		62		μС				
E _{rr}		T _j = 150 °C		28		mJ				
R _{th(j-c)}	per diode			0.13	K/W					
R _{th(c-s)}	per diode (λ _{grease} =0		0.038		K/W					
R _{th(c-s)}	per diode, pre-applied phase change material			0.032		K/W				
Module	•									
L _{CE}				15		nH				
R _{CC'+EE'}	measured per	T _C = 25 °C		0.55		mΩ				
	switch	T _C = 125 °C		0.85		mΩ				
Rth _{(c-s)1}	calculated without thermal coupling			0.008		K/W				
Rth _{(c-s)2}	including thermal cornection Ts underneath mod $(\lambda_{grease}=0.81 \text{ W/(m}^*))$		0.013		K/W					
Rth _{(c-s)2}	including thermal coupling, Ts underneath module, pre-applied phase change material			0.009		K/W				
Ms	to heat sink M6		3		5	Nm				
M _t		to terminals M6	2.5		5	Nm				
						Nm				
W					325	g				

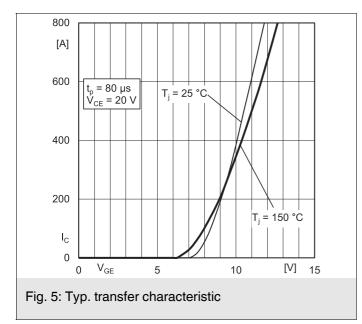


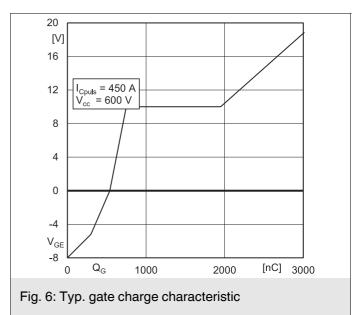


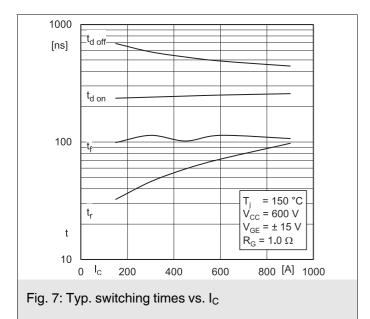


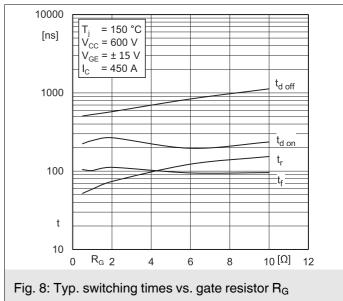


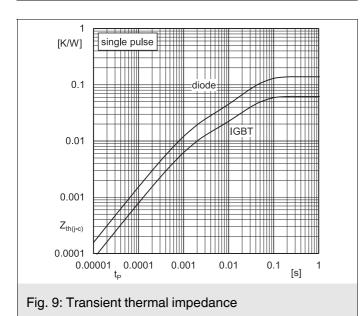


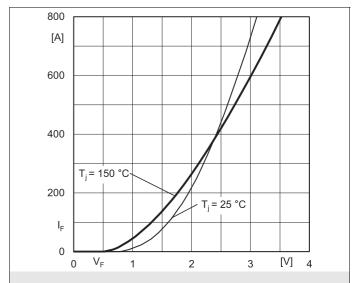












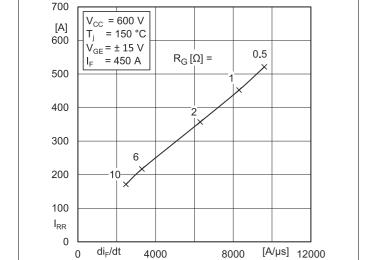
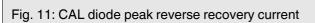


Fig. 10: Typ. CAL diode forward charact., incl. $R_{\text{CC}'\text{+ }\text{EE'}}$



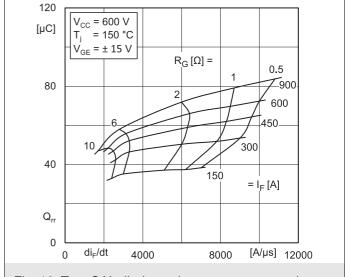
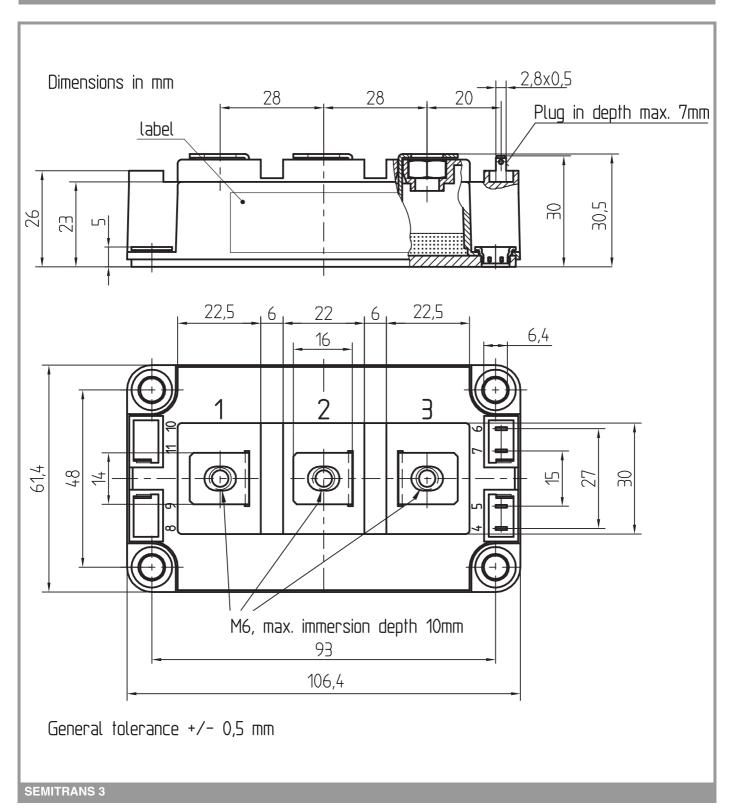
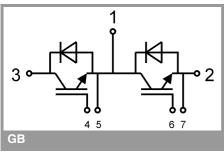


Fig. 12: Typ. CAL diode peak reverse recovery charge





This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

*IMPORTANT INFORMATION AND WARNINGS

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